







#### 30V DUAL P-CHANNEL ENHANCEMENT MODE MOSFET

## **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub> Max	I <sub>D</sub> T <sub>A</sub> = 25°C (Notes 4 & 6)	
201/	25m $\Omega$ @ V <sub>GS</sub> = -10V	-8.3A	
-30V	41mΩ @ V <sub>GS</sub> = -4.5V	-6.5A	

## **Description and Applications**

This MOSFET has been designed to minimize the on-state resistance and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- DC-DC Converters
- Power Management functions
- Disconnect Switches
- Motor control

### **Features and Benefits**

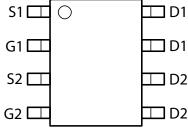
- Low on-resistance
- Fast switching speed
- Low threshold
- Low gate drive
- "Lead-Free", RoHS compliant (Note 1)
- Halogen and Antimony Free. "Green" Device (Note 1)
- Qualified to AEC-Q101 Standards for High Reliability

#### **Mechanical Data**

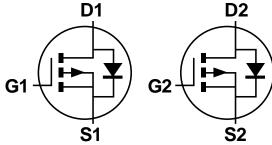
- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0 (Note 1)
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish; Solderable per MIL-STD-202, Method 208
- Weight: 0.074 grams (approximate)







Top View



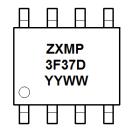
**Equivalent Circuit** 

### **Ordering Information** (Note 1)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXMP3F37DN8TA	ZXMP3F37D	7	12	500

Notes: 1. Diodes, Inc. defines "Green" products as those which are RoHS compliant and contain no halogens or antimony compounds; further information about Diodes Inc.'s "Green" Policy can be found on our website. For packaging details, go to our website.

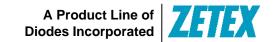
## **Marking Information**



ZXMP3F37D = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 11 = 2011) WW = Week (01 - 53)

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ZXMP3F37DN8

### Maximum Ratings @TA = 25°C unless otherwise specified

Characteristic			Symbol	Value	Unit
Drain-Source voltage			$V_{DSS}$	-30	V
Gate-Source voltage		V <sub>GS</sub>	±20	V	
Continuous Drain current		(Notes 3 & 5)	I <sub>D</sub>	-7.3	۸
	V <sub>GS</sub> = -10V	T <sub>A</sub> = 70°C (Notes 3 & 5)		-5.9	
		(Notes 2 & 5)		-5.7	A
		(Note 7)		-8.3	
Pulsed Drain current		(Notes 4)	I <sub>DM</sub>	-36	Α
Continuous Source current (Body diode)		(Notes 3)	Is	-3.5	Α
Pulsed Source current (Body diode) (Notes 4)		(Notes 4)	I <sub>SM</sub>	-36	Α

## Thermal Characteristics @TA = 25°C unless otherwise specified

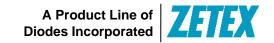
Characteristic		Symbol	Value	Unit	
Power dissipation Linear derating factor	(Notes 2 & 5)		1.25 10.0		
	(Notes 2 & 6)		1.81 14	W	
	(Notes 3 & 5) (Notes 2 & 7)	P <sub>D</sub>	2.1 17	mW/°C	
			2.7 22		
Thermal Resistance, Junction to Ambient	(Notes 2 & 5)		100		
	(Notes 2 & 6)	$R_{\theta JA}$	70	1	
	(Notes 3 & 5)		60	°C/W	
Thermal Resistance, Junction to Lead	(Notes 2 & 7)	$R_{ heta JL}$	46	]	
Operating and storage temperature range		T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	°C	

Notes:

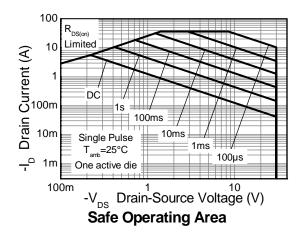
- For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
   For a dual device surface mounted on FR4 PCB measured at t ≤ 10 sec.
   Repetitive rating on 25mm X 25mm FR4 PCB, pulsed with D = 0.02 and pulse width 300µs pulse width limited by maximum junction temperature.

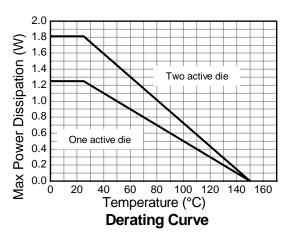
- 5. For a dual device with one active die.
- 6. For a device with two active die running at equal power.
- 7. Thermal resistance from junction to solder-point (at the end of the drain lead).

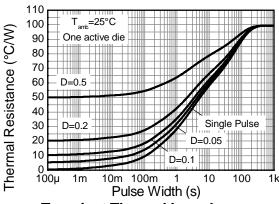


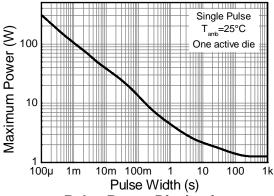


## **Thermal Characteristics**







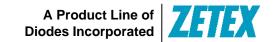


**Transient Thermal Impedance** 

**Pulse Power Dissipation** 

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ZXMP3F37DN8

## Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

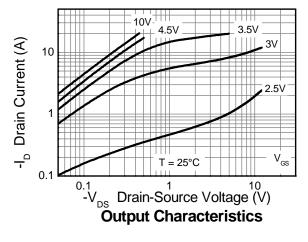
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	-30			V	$I_D = -250 \mu A$ , $V_{GS} = 0 V$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	-0.5	μΑ	$V_{DS} = -30V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS							
Gate Threshold Voltage	V <sub>GS(th)</sub>	-1.0	1	-3.0	V	$I_D = -250 \mu A$ , $V_{DS} = V_{GS}$	
Static Drain-Source On-Resistance (Note 8)	D	_	_	25	mΩ	$V_{GS} = -10V, I_D = -7.1A$	
Static Drain-Source On-Resistance (Note 8)	R <sub>DS</sub> (ON)			41	11122	$V_{GS} = -4.5V$ , $I_D = -5.5A$	
Forward Transconductance (Notes 8 & 9)	9 <sub>fs</sub>	_	18.6	_	S	$V_{DS} = -15V, I_{D} = -7.1A$	
Diode Forward Voltage (Note 8)	$V_{SD}$	_	-0.8	-1.2	V	$I_S = -1.7A$ , $V_{GS} = 0V$	
Reverse recovery time (Note 9)	t <sub>rr</sub>		16.2	_	ns	1 0 0 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	
Reverse recovery charge (Note 9)	Q <sub>rr</sub>	_	10	_	nC	I <sub>S</sub> = -2.2A, di/dt = 100A/μs	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C <sub>iss</sub>	_	1678	_	pF	V 45V V 6V	
Output Capacitance	Coss	_	303	_	pF	V <sub>DS</sub> = -15V, V <sub>GS</sub> = 0V -f = 1MHz	
Reverse Transfer Capacitance	C <sub>rss</sub>	_	178	_	pF	I = IIVIHZ	
Total Gate Charge (Note 10)	Qg	_	31.6	_	nC	101/11/	
Gate-Source Charge (Note 10)	$Q_{gs}$	_	4.3	_	nC	$V_{GS} = -10V, V_{DS} = -15V,$ $I_{D} = -7.1A$	
Gate-Drain Charge (Note 10)	Q <sub>gd</sub>	_	6.2	_	nC		
Turn-On Delay Time (Note 10)	t <sub>D(on)</sub>	_	3.5	_	ns		
Turn-On Rise Time (Note 10)	t <sub>r</sub>	_	4.9	_	ns	V <sub>DD</sub> = -15V, V <sub>GS</sub> = -10V	
Turn-Off Delay Time (Note 10)	t <sub>D(off)</sub>	_	44	_	ns	$I_D = -1A, R_G \cong 6.0\Omega$	
Turn-Off Fall Time (Note 10)	t <sub>f</sub>	_	28	_	ns	]	

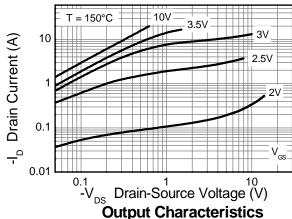
Notes:

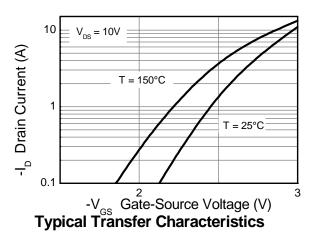
- 8. Measured under pulsed conditions. Pulse width  $\leq 300 \mu s;$  duty cycle  $\leq 2\%$
- For design aid only, not subject to production testing.
   Switching characteristics are independent of operating junction temperatures.

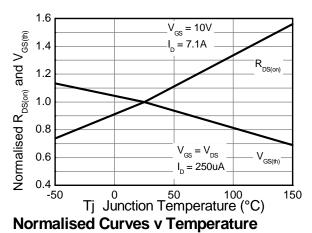


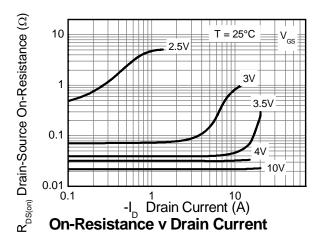
## **Typical Characteristics**

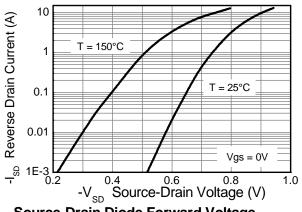








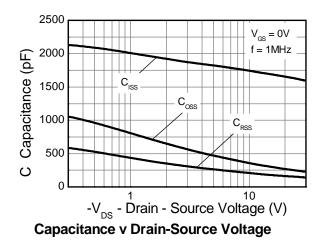


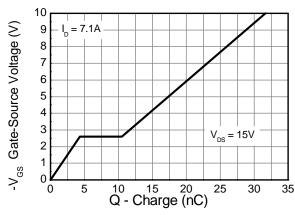


**Source-Drain Diode Forward Voltage** 



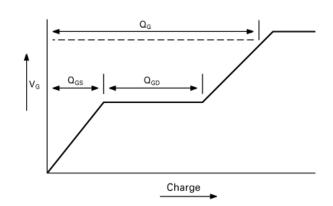
## **Typical Characteristics - continued**





Gate-Source Voltage v Gate Charge

### **Test Circuits**

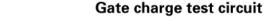


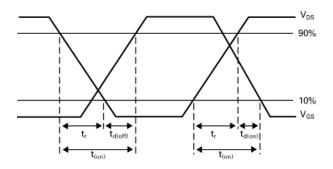
Current regulator

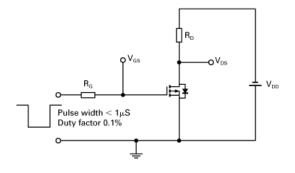
12V 0.2μF 50k D.U.T

V<sub>os</sub>

Basic gate charge waveform



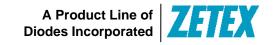




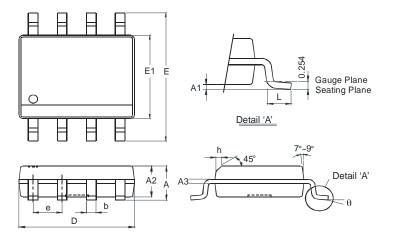
Switching time waveforms

Switching time test circuit



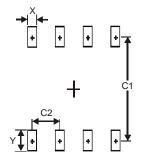


# **Package Outline Dimensions**



SO-8					
Dim	Min	Max			
Α	-	1.75			
A1	0.10	0.20			
A2	1.30	1.50			
A3	0.15	0.25			
b	0.3	0.5			
D	4.85	4.95			
Е	5.90	6.10			
E1	3.85	3.95			
е	1.27 Typ				
h	-	0.35			
L	0.62	0.82			
θ	0°	8°			
All Dimensions in mm					

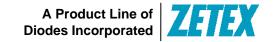
# **Suggested Pad Layout**



Dimensions	Value (in mm)
X	0.60
Y	1.55
C1	5.4
C2	1.27

### DISCONTINUED





ZXMP3F37DN8

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